## Features

## - High Gain

$\square+34 \mathrm{dBm}$ Power Output
Proprietary Power FET Process
$\square>45 \%$ Linear Power Added Efficiency
$\square+29 \mathrm{dBm}$ with 30 dBc Third Order Products

- Surface Mount SO-8 Power Package


## Applications

- ISM Band Base Stations and Terminals
- Cellular Base Stations and Terminals
$\square$ Wireless Local Loop


## Description

The CFK2162-P1 is a high-gain FET intended for driver amplifier applications in high-power systems, and output stage usage in medium power applications at power levels up to +34 dBm . The device is easily matched and provides excellent

Specifications ( $\mathrm{TA}=25^{\circ} \mathrm{C}$ ) The following specifications are guaranteed at room temperature in Celeritek test fixture at 850 MHz .

| Parameters | Conditions | Min | Typ | Max | Units |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{d}}=\mathbf{8 V}, \mathbf{I}_{\mathbf{d}}=\mathbf{8 0 0} \mathbf{~ m A}$ (Quiescent) |  |  |  |  |  |
| $\mathbf{P}_{\mathbf{- 1 d B}}$ |  | 33.0 | 34.0 | - | dBm |
| $\mathbf{S S G}$ |  | 19.0 | 20.0 | - | dB |
| 3rd Order <br> Products |  | 26 | 30 | - | dBc |
| Efficiency | @ P1dB | - | 43 | - | $\%$ |

$\mathbf{V}_{\mathbf{d}}=\mathbf{5 V}, \mathrm{I}_{\mathbf{d}}=\mathbf{3 5 0} \mathrm{mA}$ (Quiescent)

| $\mathbf{P} \mathbf{- 1 d B}$ |  | - | 30.0 | - | dBm |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathbf{S S G}$ |  | - | 18.0 | - | dB |


| $\mathbf{V}_{\mathbf{d}}=\mathbf{5 V}, \mathbf{I}_{\mathbf{d}}=\mathbf{1 2 0 0} \mathbf{~ m A}$ (Quiescent) |  |  |  |  |  |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathbf{P}_{\mathbf{- 1 d B}}$ |  | - | 33.0 | - | dBm |
| SSG |  | - | 19.0 | - | dB |


| Parameters | Conditions | Min | Typ | Max | Units |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathbf{g}_{\mathbf{m}}$ | Vds $=2.0 \mathrm{~V}, \mathrm{Vgs}=0 \mathrm{~V}$ | - | 1700 | - | mS |
| $\mathbf{I}_{\mathbf{d s s}}$ | Vds $=2.0 \mathrm{~V}, \mathrm{Vgs}=0 \mathrm{~V}$ | - | 2.8 | - | A |
| $\mathbf{V}_{\mathbf{p}}$ | Vds $=3.0 \mathrm{~V}, \mathrm{Ids}=65 \mathrm{~mA}$ | - | -1.8 |  | Volts |
| $\mathbf{B V}_{\mathbf{G D}}{ }^{(3)}$ | $\mathrm{Igd}=6.5 \mathrm{~mA}$ | 18 | 20 | - | Volts |
| $\Theta_{\mathbf{J L}}{ }^{(2)}$ | $@ 150^{\circ} \mathrm{C} \mathrm{TCH}$ | - | 10 | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## Notes:

1. Sum to two tones with 1 MHz spacing $=29 \mathrm{dBm}$.
2. See thermal considerations information on page 4.
3. $\mathrm{Max}\left(+\mathrm{V}_{\mathrm{d}}\right)$ and $\left(-\mathrm{V}_{\mathrm{g}}\right)$ under linear operation. Max potential difference across the device in RF compression $\left(2 \mathrm{~V}_{\mathrm{d}}+\left|-\mathrm{V}_{\mathrm{g}}\right|\right)$ not to exceed the minimum breakdown voltage $\left(\mathrm{V}_{\mathrm{br}}\right)$ of +18 V .

## Package Diagram


linearity at 2 Watts. Manufactured in Celeritek's proprietary power FET process, this device is assembled in an industry standard surface mount SO-8 power package that is compatible with high volume, automated board assembly techniques.

## Absolute Maximum Ratings

| Parameter | Symbol | Rating |
| :--- | :---: | :---: |
| Drain-Source Voltage | $\mathrm{V}_{\mathrm{DS}}$ | $12 \mathrm{~V}^{(3)}$ |
| Gate-Source Voltage | $\mathrm{V}_{\mathrm{GS}}$ | -5 V |
| Drain Current | $\mathrm{I}_{\mathrm{DS}}$ | Idss |
| Continuous Dissipation | $\mathrm{P}_{\mathrm{T}}$ | 10 W |
| Channel Temperature | $\mathrm{T}_{\mathrm{CH}}$ | $175^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ | $-65^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |

## SO-8 Power Package Physical Dimensions



| DIMENSION | MINIMUM | NOMINAL | MAXIMUM |
| :---: | :---: | :---: | :---: |
| A |  | $.086[2.184]$ | $.100[2.540]$ |
| A 1 | $.005[.1270]$ | $.008[.2032]$ | $.011[.2794]$ |
| b | $.017[.4318]$ | $.020[.5080]$ | $.023[.5842]$ |
| c | $.007[.1778]$ | $.008[2032]$ | $.009[.2286]$ |
| D | $.195[4.953]$ | $.200[5.080]$ | $.205[5.207]$ |
| E | $.135[3.429]$ | $.140[3.556]$ | $.145[3.683]$ |
| E 1 | $.155[3.937]$ | $.160[4.064]$ | $.165[4.191]$ |
| e |  | $.050[1.270]$ |  |
| L | $.020[.5080]$ |  | $.040[1.016]$ |
| L 1 | $.055[1.397]$ | $.065[1.651]$ | $.075[1.905]$ |
| $\alpha$ | 0 |  | 8 |

Typical Scattering Parameters $\quad\left(\mathrm{TA}=\mathbf{2 5}{ }^{\circ} \mathrm{C}, \mathrm{Vds}=5 \mathrm{~V}\right.$, Ids $\left.=\mathbf{3 5 0} \mathrm{mA}\right)$

| $\begin{aligned} & \text { Frequency } \\ & (\mathrm{GHz}) \end{aligned}$ | $\mathrm{S}_{11}$ |  | $\mathrm{S}_{21}$ |  | $\mathrm{S}_{12}$ |  | $\mathrm{S}_{22}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Mag | Ang | Mag | Ang | Mag | Ang | Mag | Ang |
| 0.6 | 0.946 | -162.45 | 4.973 | 86.73 | 0.017 | 11.14 | 0.739 | 172.95 |
| 0.7 | 0.945 | -162.45 | 4.973 | 86.73 | 0.017 | 11.14 | 0.739 | 172.95 |
| 0.8 | 0.946 | -171.49 | 3.657 | 79.26 | 0.019 | 8.47 | 0.746 | 170.91 |
| 0.9 | 0.947 | -174.16 | 3.22 | 76.4 | 0.018 | 7.15 | 0.749 | 170.28 |
| 1.0 | 0.946 | -176.06 | 2.885 | 73.75 | 0.018 | 9.37 | 0.748 | 169.73 |
| 1.1 | 0.946 | -177.58 | 2.623 | 71.82 | 0.018 | 6.8 | 0.747 | 169.56 |
| 1.2 | 0.945 | -178.58 | 2.424 | 69.66 | 0.019 | 6.59 | 0.746 | 169.16 |
| 1.3 | 0.944 | -179.55 | 2.27 | 67.7 | 0.019 | 6.53 | 0.742 | 168.8 |
| 1.4 | 0.942 | 179.53 | 2.154 | 65.68 | 0.02 | 7.04 | 0.739 | 168.03 |
| 1.5 | 0.938 | 178.31 | 2.055 | 63.25 | 0.02 | 4.93 | 0.73 | 167.15 |
| 2.0 | 0.918 | 166.09 | 1.777 | 46.63 | 0.025 | -1.23 | 0.694 | 155.54 |
| 2.5 | 0.915 | 144.67 | 1.448 | 24.9 | 0.025 | -19.64 | 0.703 | 137.27 |
| 3.0 | 0.941 | 132.34 | 1.033 | 10.11 | 0.022 | -27.73 | 0.76 | 128.69 |
| 3.5 | 0.957 | 134.66 | 0.803 | 6.12 | 0.02 | -21.78 | 0.787 | 132.92 |
| 4.0 | 0.94 | 138.76 | 0.803 | 1.66 | 0.023 | -20.57 | 0.74 | 136.51 |
| $\mathbf{( T A}=\mathbf{2 5}{ }^{\circ} \mathrm{C}, \mathrm{Vds}=\mathbf{5} \mathbf{~ V}$, Ids $\left.=\mathbf{1 2 0 0} \mathbf{~ m A}\right)$ |  |  |  |  |  |  |  |  |
| 0.6 | 0.95 | -165 | 5.311 | 84.94 | 0.014 | 13.61 | 0.747 | 17.19 |
| 0.7 | 0.951 | -169.94 | 4.491 | 80.91 | 0.013 | 15.25 | 0.75 | 170.93 |
| 0.8 | 0.951 | -173.53 | 3.878 | 77.66 | 0.014 | 13.21 | 0.75 | 170.03 |
| 0.9 | 0.952 | -176.07 | 3.406 | 74.74 | 0.013 | 13.59 | 0.75 | 169.43 |
| 1.0 | 0.951 | -177.94 | 3.044 | 72.23 | 0.014 | 14.39 | 0.749 | 168.92 |
| 1.1 | 0.951 | -179.34 | 2.767 | 70.37 | 0.014 | 13.01 | 0.749 | 168.72 |
| 1.2 | 0.951 | 179.72 | 2.561 | 68.34 | 0.014 | 14.6 | 0.745 | 168.29 |
| 1.3 | 0.951 | 178.92 | 2.391 | 66.48 | 0.015 | 13.62 | 0.741 | 167.98 |
| 1.4 | 0.949 | 177.92 | 2.272 | 64.41 | 0.015 | 14.21 | 0.734 | 167.24 |
| 1.5 | 0.946 | 176.83 | 2.169 | 61.99 | 0.016 | 14.13 | 0.728 | 166.28 |
| 2.0 | 0.929 | 165.15 | 1.88 | 45.76 | 0.02 | 7.43 | 0.69 | 154.9 |
| 2.5 | 0.925 | 144.23 | 1.529 | 24.16 | 0.022 | -7.75 | 0.698 | 136.7 |
| 3.0 | 0.947 | 131.72 | 1.09 | 9.25 | 0.018 | -17.77 | 0.757 | 127.79 |
| 3.5 | 0.961 | 133.41 | 0.853 | 4.59 | 0.017 | -13.03 | 0.779 | 131.26 |
| 4.0 | 0.945 | 137.83 | 0.85 | 0.36 | 0.021 | -8.72 | 0.73 | 134.73 |
| $\left(\mathbf{T A}=25^{\circ} \mathrm{C}, \mathrm{Vds}=\mathbf{8} \mathrm{V}\right.$, Ids $\left.=800 \mathrm{~mA}\right)$ |  |  |  |  |  |  |  |  |
| 0.6 | 0.941 | -164.65 | 5.654 | 83.55 | 0.015 | 10.74 | 0.676 | 174.61 |
| 0.7 | 0.944 | -169.57 | 4.772 | 79.47 | 0.014 | 10.38 | 0.682 | 173.44 |
| 0.8 | 0.946 | -172.92 | 4.131 | 75.86 | 0.015 | 9.99 | 0.685 | 172.69 |
| 0.9 | 0.947 | -175.57 | 3.625 | 72.68 | 0.014 | 10.72 | 0.687 | 172.32 |
| 1.0 | 0.947 | -177.32 | 3.25 | 70.11 | 0.015 | 8.2 | 0.688 | 171.96 |
| 1.1 | 0.946 | -178.65 | 2.944 | 67.96 | 0.015 | 8.47 | 0.688 | 172.02 |
| 1.2 | 0.947 | -179.63 | 2.717 | 65.66 | 0.015 | 9.51 | 0.687 | 171.82 |
| 1.3 | 0.945 | 179.49 | 2.535 | 63.48 | 0.015 | 7.84 | 0.684 | 171.67 |
| 1.4 | 0.944 | 178.52 | 2.397 | 61.32 | 0.016 | 8.5 | 0.68 | 171.06 |
| 1.5 | 0.941 | 177.34 | 2.85 | 58.65 | 0.016 | 9.62 | 0.674 | 170.41 |
| 2.0 | 0.923 | 165.04 | 12.949 | 41.52 | 0.019 | -1.07 | 0.639 | 159.85 |
| 2.5 | 0.92 | 143.82 | 1.579 | 19.18 | 0.02 | -12.64 | 0.653 | 141.46 |
| 3.0 | 0.944 | 131.73 | 1.116 | 3.58 | 0.018 | -21.43 | 0.722 | 132.33 |
| 3.5 | 0.96 | 134.09 | 0.857 | -1.39 | 0.016 | -16.54 | 0.762 | 136.36 |
| 4.0 | 0.942 | 137.96 | 0.841 | -6.32 | 0.02 | -10.57 | 0.723 | 140.71 |

RF Match Data shown in the performance graphs was taken in the test circuits shown at right and on page 3. Layout is important for proper operation. Phase length of input and output $50 \Omega$ line varies as a function of exact desired frequency of operation. Output shunt inductor effects output performance. Celeritek recommends the use of a high impedance printed inductor Lambda/4 in length. Please contact the factory for an evaluation board and/or more detailed application support.


## Typical Performance

Power Output \& Power Added Efficiency vs Power Input



Power Output \& 3rd Order Products vs Power Input


Power Output \& Power Added Efficiency vs Power Input



Power Output \& 3rd Order Products vs Power Input




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## Thermal Considerations

The data shown was taken on a 31 mil thick FR-4 board with 1 ounce copper on both sides. The board was mounted to a baseplate with 3 screws as shown. The screws bring the top side copper temperature to the same value as the baseplate. The thermal resistance to the indicated reference lead, $\Theta_{\mathrm{JL}}$, is $10^{\circ} \mathrm{C} / \mathrm{W}$. The thermal resistance to the reference screw is $12^{\circ} \mathrm{C} / \mathrm{W}$.

1. Use 1 or 2 ounce copper if possible.
2. Solder all eight leads of the CFK2162-P1 package to the appropriate electrical connection.
3. Solder the copper pad on the backside of the CFK2162-P1 package to the ground plane.
4. Use a large ground pad area with many plated through-holes as shown.
5. If possible, use at least one screw no more than 0.2 inches from the CFK2162-P1 package to provide a low thermal resistance path to the baseplate of the package.


## Ordering Information

The CFK2162-P1 power stage is available in a SO-8 surface mount package. Devices are available in tape and reel. Ordering part numbers are listed.

## Part Number for Ordering <br> CFK2162-P1 <br> CFK2162-P1-000T

Function
800-900 MHz Power Stage 800-900 MHz Power Stage

Package
SO-8 surface mount power package
SO-8 surface mount power package in tape and reel

